

SANYO Semiconductors **DATA SHEET**

LC863448B, LC863440B LC863432B, LC863428B LC863424B, LC863420B LC863416B

CMOS IC FROM 48K/40K/32K/28K/24K/20K/16K-byte, RAM 640/512-byte on-chip and 352 \times 9-bit OSD RAM

8-bit 1-chip Microcontroller

Overview

The LC863448/40/32/28/24/20/16B are 8-bit single chip microcontrollers with the following on-chip functional blocks:

- CPU : Operable at a minimum bus cycle time of 0.424µs
- On-chip ROM capacity

Program ROM: 48K/40K/32K/28K/24K/20K/16K-bytes

CGROM: 16K-bytes

- On-chip RAM capacity: 640/512-bytes
- OSD RAM: 352 × 9-bits
- Closed-Caption TV controller and the on-screen display controller
- Closed-Caption data slicer
- Four channels × 6-bit AD Converter
- Three channels × 7-bit PWM
- 16-bit timer/counter, 14-bit base timer
- IIC-bus compliant serial interface circuit (Multi-master type)
- ROM correction function
- 12-source 8-vectored interrupt system
- Integrated system clock generator and display clock generator

Only one X'tal oscillator (32.768kHz) for PLL reference is used for both generators

TV control and the Closed Caption function

All of the above functions are fabricated on a single chip.

- Any and all SANYO products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your SANYO representative nearest you before using any SANYO products described or contained herein in such applications.
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Features

■ Read-Only Memory (ROM) : 49152×8 -bits/ 40960×8 -bits/ 32768×8 -bits/

28672 × 8-bits/24576 × 8-bits/20480 × 8-bits/

16384 × 8-bits for program 16128 × 8-bits for CGROM

■Random Access Memory (RAM) : 512 × 8-bits (working area) : LC863448B/40B

384 × 8-bits (working area) : LC863432B/28B/24B/20B/16B

128 × 8-bits (working or ROM correction function)

352 × 9-bits (for CRT display)

■OSD functions

• Screen display : 36 characters × 16 lines (by software)

• RAM : 352 words (9-bits per word)

Display area: $36 \text{ words} \times 8 \text{ lines}$ Control area: $8 \text{ words} \times 8 \text{ lines}$

• Characters

Up to 252 kinds of 16×32 dot character fonts (4 characters including 1 test character are not programmable)

Each font can be divided into two parts and used as two fonts (Ex. 16×16 dot character font \times 2)

At least 111 characters need to be divide between a 16×17 dot and 8×9 dot character font to display the caption fonts.

• Various character attributes

Character colors : 16 colors (analog mode : 1 Vp-p output) /8 colors (digital mode)
Character background colors : 16 colors (analog mode : 1 Vp-p output) /8 colors (digital mode)
Fringe/shadow colors : 16 colors (analog mode : 1 Vp-p output) /8 colors (digital mode)
Full screen colors : 16 colors (analog mode : 1 Vp-p output) /8 colors (digital mode)

Rounding Underline

Italic character (slanting)

- Attribute can be changed without spacing
- Vertical display start line number can be set for each row independently (Rows can be overlapped)
- Horizontal display start position can be set for each row independently
- Horizontal pitch (bit 9 to 16) *1 and vertical pitch (bit 1 to 32) can be set for each row independently
- Different display modes can be set for each row independently

Caption • Text mode/OSD mode 1/OSD mode 2 (Quarter size) /Simplified graphic mode

• Ten character sizes *1

Horez.
$$\times$$
 Vert. = (1×1) , (1×2) , (2×2) , (2×4) , (0.5×0.5)
 (1.5×1) , (1.5×2) , (3×2) , (3×4) , (0.75×0.5)

- Shuttering and scrolling on each row
- Simplified Graphic Display
- *1 Note: range depends on display mode: refer to the manual for details.

■Data Slicer (closed caption format)

- Closed caption data and XDS data extraction
- NTSC/PAL, and extracted line can be specified

■Bus Cycle Time/Instruction-Cycle Time

Bus cycle time	Instruction cycle time	Clock divider	System clock oscillation	Oscillation frequency	Voltage
0.424µs	0.848µs	1/2	Internal VCO	14.156MHz	4.5V to 5.5V
0.424μ5	0.040μ5	1/2	(Ref : X'tal 32.768kHz)	14.130W112	4.57 10 3.57
7.5µs	15.0μs	1/2	Internal RC	800kHz	4.5V to 5.5V
91.55μs	183.1μs	1/1	Crystal	32.768kHz	4.5V to 5.5V
183.1μs	366.2μs	1/2	Crystal	32.768kHz	4.5V to 5.5V

■Ports

• Input/Output Ports : 4 ports (23 terminals)
Data direction programmable in nibble units : 1 port (8 terminals)

(If the N-ch open drain output is selected by option, the corresponding port data can be read in output mode.)

Data direction programmable for each bit individually: 3 ports (15 terminals)

■AD converter

• 4 channels × 6-bit AD converters

■Serial interfaces

• IIC-bus compliant serial interface (Multi-master type)

Consists of a single built-in circuit with two I/O channels. The two data lines and two clock lines can be connected internally.

■PWM output

• 3 channels × 7-bit PWM

■Timer

• Timer 0 : 16-bit timer/counter

With 2-bit prescaler + 8-bit programmable prescaler

Mode 0: Two 8-bit timers with a programmable prescaler

Mode 1:8-bit timer with a programmable prescaler +8-bit counter

Mode 2: 16-bit timer with a programmable prescaler

Mode 3: 16-bit counter

The resolution of timer is 1 tCYC.

• Base timer

Generate every 500ms overflow for a clock application

(using 32.768kHz crystal oscillation for the base timer clock)

Generate every 976µs, 3.9ms, 15.6ms, 62.5ms overflow

(using 32.768kHz crystal oscillation for the base timer clock)

Clock for the base timer is selectable from 32.768kHz crystal oscillation, system clock or programmable prescaler output of Timer 0

■Remote control receiver circuit (connected to the P73/INT3/T0IN terminal)

- Noise rejection function
- Polarity switching

■Watchdog timer

External RC circuit is required

Interrupt or system reset is activated when the timer overflows

■ROM correction function

Max 128-bytes/2 addresses

■Interrupts

- 12 sources 8 vectored interrupts
 - 1. External Interrupt INT0
 - 2. External Interrupt INT1
 - 3. External Interrupt INT2, Timer/counter T0L (Lower 8-bits)
 - 4. External Interrupt INT3, base timer
 - 5. Timer/counter T0H (Upper 8-bits)
 - 6. Data slicer
 - 7. Vertical synchronous signal interrupt (\overline{VS}) , horizontal line (\overline{HS})
 - 8. IIC, Software
- Interrupt priority control

Three interrupt priorities are supported (low, high and highest) and multi-level nesting is possible.

Low or high priority can be assigned to the interrupts from 3 to 8 listed above.

For the external interrupt INT0 and INT1, low or highest priority can be set.

■Sub-routine stack level

• A maximum of 128 levels (stack is built in the internal RAM)

■Multiplication/division instruction

- 16-bits × 8-bits (7 instruction cycle times)
- 16-bits ÷ 8-bits (7 instruction cycle times)

■3 oscillation circuits

- Built-in RC oscillation circuit used for the system clock
- Built-in VCO circuit used for the system clock and OSD
- X'tal oscillation circuit used for base timer, system clock and PLL reference

■Standby function

• HALT mode

The HALT mode is used to reduce the power dissipation. In this operation mode, the program execution is stopped. This mode can be released by the interrupt request or the system reset.

• HOLD mode

The HOLD mode is used to stop the oscillations; RC (internal), VCO, and X'tal oscillations.

This mode can be released by the following conditions.

- Pull the reset terminal (\overline{RES}) to low level.
- Feed the selected level to either P70/INT0 or P71/INT1.

■Package

- MFP36S
- DIP36S

■Development tools

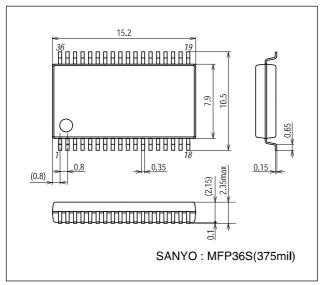
Flash EEPROM : LC86F3448AEvaluation chip : LC863096

• Emulator : EVA86000 (main) + ECB863200A (evaluation chip board)

+ SUB863400A (sub board) + POD36-CABLE (cable) + POD36-DIP (for DIP36S) or POD36-MFP (for MFP36S)

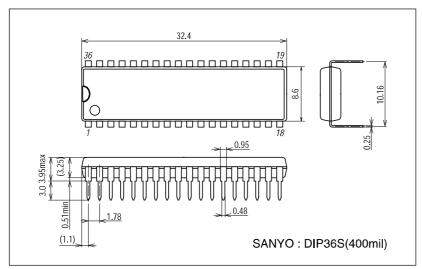
Package Dimensions

unit : mm 3204B

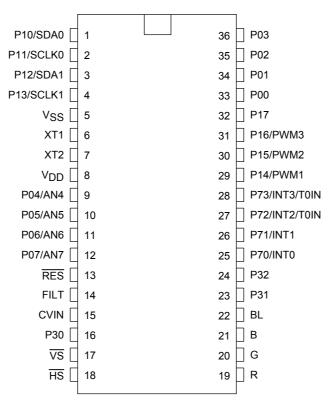


Package Dimensions

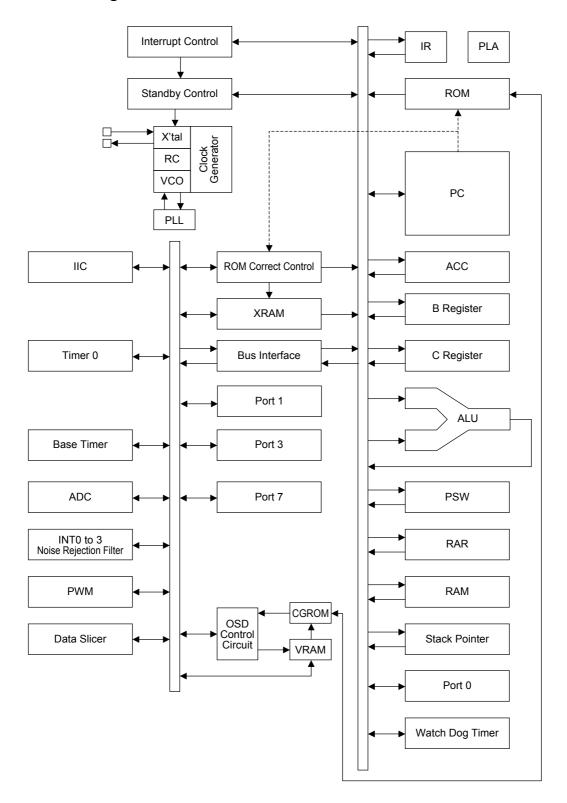
unit : mm 3170A



Pin Assignment



System Block Diagram



Pin Description

i iii Desci	iption							
Pin name	I/O			Function				Option
V _{SS}	-	Negative power s	supply					
XT1	1	Input terminal for	crystal oscillator					
XT2	0	Output terminal for	or crystal oscillator					
V_{DD}	-	Positive power su	ıpply					
RES	I	Reset terminal						
FILT	0	Filter terminal for	PLL					
CVIN	I	Video signal inpu	t terminal					
VS	I	Vertical synchron	ization signal input t	terminal				
HS	I	Horizontal synchr	onization signal inp	ut terminal				
R	0	Red (R) output te	rminal of RGB imag	e output				
G	0	Green (G) output	terminal of RGB im	age output				
В	0	Blue (B) output te	erminal of RGB imag	je output				
BL	0	Fast blanking cor	ntrol signal					
		Switch TV image	signal and caption/0	OSD image si	gnal			
Port 0	I/O	8-bit input/output	ıt port					Pull-up resistor
P00 to P07			be specified in nibb					provided/not provided
		read in output n	n drain output is sele	ected by option	n, the corres	ponding port of	lata can be	Output Format CMOS/Nch-OD
		•Other functions	ioue.)					CIVIOS/NCII-OD
			out port (P04 to P07	: 4 channels)				
Port 1	I/O	•8-bit input/output	t port					Output Format
P10 to P17			be specified for each					CMOS/Nch-OD
			pull-up resister prov	ided)				
		•Other functions	C0 data I/O					
			C0 clock output					
			C1 data I/O					
		P13 II	C1 clock output					
		P14 F	WM1 output					
			WM2 output					
		P16 F	PWM3 output					
Port 3	I/O	•3-bit input/output	t port					
P30 to P32		Input/output can	be specified for each	h bit				
		(CMOS output/ir	put with programma	able pull-up re	sister)			
Port 7	I/O	•4-bit input/outpu	•					
P70		,	an be specified for e			٦		
P71 to P73			n programmable pull CMOS output/input	-	mable null-u	n resister		
		•Other function	omoo oatpatinipat	mai program	nable pail a	p redictor y		
		P70	INT0 input/HOLD re	elease input/				
			Nch-Tr. Output for	watchdog time	er			
		P71	INT1 input/HOLD re	•				
		P72 P73	INT2 input/Timer 0	•	onnootod)			
			INT3 input (noise re /Timer 0 event inpu	-	orinected)			
		Interrupt receiver	format, vector addre				l	
		ris	sing falling	rising/ falling	H level	L level	vector	
		INTO en	able enable	disable	enable	enable	03H	
		INT1 en	able enable	disable	enable	enable	0BH	
		INT2 en	able enable	enable	disable	disable	13H	
		INT3 en	able enable	enable	disable	disable	1BH	
			•		•			

Note: A capacitor of at least 10µF must be inserted between VDD and VSS when using this IC.

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- Output form and existence of pull-up resistor for all ports can be specified for each bit.
- Programmable pull-up resistor is always connected regardless of port option, CMOS or N-ch open drain output in port 1.

• Port status in reset

	Terminal	I/O	Pull-up resistor status at selecting CMOS output option
Γ	Port 0	1	Pull-up resistor OFF, ON after reset release
Ī	Port 1	1	Programmable pull-up resistor OFF

Absolute Maximum Ratings / Ta = 25°C, $V_{SS} = 0V$

Dore	ameter	Cumbal	Pins	Conditions			Li	mits	
Pala	ameter	Symbol	Pins	Conditions	V _{DD} [V]	min	typ	max	unit
Supply vo	oltage	V _{DD} max	V _{DD}			-0.3		+7.0	
Input volt	age	V _I (1)	RES, HS, VS, CVIN			-0.3		V _{DD} +0.3	v
Output vo	oltage	V _O (1)	R, G, B, BL, FILT			-0.3		V _{DD} +0.3	V
Input/out	put voltage	V _{IO}	Ports 0, 1, 3, 7			-0.3		V _{DD} +0.3	
High level	Peak output	IOPH(1)	Ports 0, 1, 3, 7	CMOS output For each pin.		-4			
output current	current	IOPH(2)	R, G, B, BL	CMOS output For each pin.		-5			
	Total	ΣΙΟΑΗ(1)	Ports 0, 1	The total of all pins.		-20			
	output	ΣΙΟΑΗ(2)	Ports 3, 7	The total of all pins.		-10			
	current	ΣΙΟΑΗ(3)	R, G, B, BL	The total of all pins.		-12			mA
Low	Peak	IOPL(1)	Ports 0, 1, 3	For each pin.				20	''''
level	output	IOPL(2)	Port 7	For each pin.				15	
output	current	IOPL(3)	R, G, B, BL	For each pin.				5	
current	Total	ΣIOAL(1)	Ports 0, 1	The total of all pins.				40	
	output	ΣIOAL(2)	Ports 3, 7	The total of all pins.				20	
	current	ΣIOAL(3)	R, G, B, BL	The total of all pins.				12	
Maximum	n power	Pd max	MFP36S	Ta = -10 to +70°C				340	
dissipatio	on		DIP36S					500	mW
Operating temperat	g ure range	Topr				-10		+70	°C
Storage temperat	ure range	Tstg				-55		+125	-0

Recommended Operating Range / $Ta = -10^{\circ}C$ to $+70^{\circ}C$, $V_{SS} = 0V$

Danamatan	O. make al	Diag	On a dition of			Lim	its	
Parameter	Symbol	Pins	Conditions	v _{DD} [V]		typ	max	unit
Operating supply	V _{DD} (1)	V _{DD}	0.844μs ≤ tCYC ≤ 0.852μs		4.5		5.5	
voltage range	V _{DD} (2)		4μs ≤ tCYC ≤ 400μs		4.5		5.5	
Hold voltage	V _{HD}	V _{DD}	RAMs and the registers data are kept in HOLD mode.		2.0		5.5	
High level input	V _{IH} (1)	Port 0	Output disable	4.5 to 5.5	0.6V _{DD}		V_{DD}	
voltage	V _{IH} (2)	Ports 1, 3 (Schumitt) Port 7 (Schumitt) port input/interrupt HS, VS, RES (Schumitt)	Output disable	4.5 to 5.5	0.75V _{DD}		V _{DD}	V
	V _{IH} (3)	Port 70 Watchdog timer input	Output disable	4.5 to 5.5	V _{DD} -0.5		V _{DD}	

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D	0	D'	0 - 177			Lim	its	
Parameter	Symbol	Pins	Conditions	V _{DD} [V]	min	typ	max	unit
Low level input	V _{IL} (1)	Port 0	Output disable	4.5 to 5.5	V _{SS}		0.2V _{DD}	
voltage	V _{IL} (2)	Ports 1, 3 (Schumitt) Port 7 (Schumitt) port input/interrupt HS, VS, RES (Schumitt)	Output disable	4.5 to 5.5	V _{SS}		0.25V _{DD}	V
	V _{IL} (3)	Port 70 Watchdog timer input	Output disable	4.5 to 5.5	V _{SS}		0.6V _{DD}	
CVIN	VCVIN	CVIN		5.0	0.7Vp-p	1Vp-p	1.4Vp-p	Vp-p*
Operation cycle time	tCYC(1)		All functions operating	4.5 to 5.5	0.844	0.848	0.852	
	tCYC(2)		OSD and Data slicer are not operating	4.5 to 5.5	0.844		400	μs
Oscillation frequency range	FmRC		Internal RC oscillation	4.5 to 5.5	0.4	0.8	3.0	MHz

^{*} Vp-p : Peak-to-peak voltage

Electrical Characteristics / $Ta = -10^{\circ}C$ to $+70^{\circ}C$, $V_{SS} = 0V$

Darameter	Cumbal	Dina	Conditions			Limit	ts	
Parameter	Symbol	Pins	Conditions	V _{DD} [V]	min	typ	max	unit
High level input current	I _{IH} (1)	Ports 0, 1, 3, 7	Output disable Pull-up MOS Tr. OFF VIN = VDD (Including the off-leak current of the output Tr.)	4.5 to 5.5			1	
	I _{IH} (2)	• RES • HS, VS	• V _{IN} = V _{DD}	4.5 to 5.5			1	
Low level input current	I _{IL} (1)	Ports 0, 1, 3, 7	Output disable Pull-up MOS Tr. OFF VIN = VSS (Including the off- leak current of the output Tr.)	4.5 to 5.5	-1			μА
	I _{IL} (2)	• RES • HS, VS	V _{IN} = V _{SS}	4.5 to 5.5	-1			
High level output voltage	V _{OH} (1)	• CMOS output of ports 0, 1, 3, 71 to 73	I _{OH} = -1.0mA	4.5 to 5.5	V _{DD} -1			
	V _{OH} (2)	R, G, B, BL	I _{OH} = -0.1mA R. G. B : digital mode	4.5 to 5.5	V _{DD} -0.5			
Low level	V _{OL} (1)	Ports 0, 1, 3, 71 to 73	I _{OL} = 10mA	4.5 to 5.5			1.5	V
output voltage	V _{OL} (2)	Ports 0, 3, 71 to 73	I _{OL} = 1.6mA	4.5 to 5.5			0.4	
	V _{OL} (3)	• R, G, B, BL • Port 1	I _{OL} = 3.0mA R. G. B : digital mode	4.5 to 5.5			0.4	
	V _{OL} (4)	Port 70	I _{OL} = 1mA	4.5 to 5.5			0.4	
Pull-up MOS Tr. resistance	Rpu	• Ports 0, 1, 3, 7	V _{OH} = 0.9V _{DD}	4.5 to 5.5	13	38	80	kΩ
Bus terminal short circuit resistance (SCL0 to SCL1, SDA0 to SDA1)	RBS	• P10 to P12 • P11 to P13		4.5 to 5.5		130	300	Ω
Hysteresis voltage	VHIS	• Ports 1, 3, 7 • RES • HS, VS	Output disable	4.5 to 5.5		0.1V _{DD}		V
Input clump voltage	VCLMP	CVIN		5.0	2.3	2.5	2.7	
Pin capacitance	CP	All pins	• f = 1MHz • Every other terminals are connected to V _{SS} . • Ta = 25°C	4.5 to 5.5		10		pF

IIC Input/Output Conditions / $Ta = -10^{\circ}C$ to $+70^{\circ}C$, $V_{SS} = 0V$

Parameter	Symbol	Stan	ndard	High	speed	unit
Parameter	Symbol	min	max	min	max	uriit
SCL Frequency	fSCL	0	100	0	400	kHz
BUS free time between stop to start	tBUF	4.7	-	1.3	1	μs
HOLD time of start, restart condition	tHD ; STA	4.0	-	0.6	ı	μs
L time of SCL	tLOW	4.7	-	1.3	-	μs
H time of SCL	tHIGH	4.0	-	0.6	-	μs
Set-up time of restart condition	tSU; STA	4.7	-	0.6		μs
HOLD time of SDA	tHD ; DAT	0	-	0	0.9	μs
Set-up time of SDA	tSU; DAT	250	-	100	-	ns
Rising time of SDA, SCL	tR	-	1000	20 + 0.1Cb	300	ns
Falling time of SDA, SCL	tF	-	300	20 + 0.1Cb	300	ns
Set-up time of stop condition	tSU; STO	4.0	-	0.6	-	μs

Refer to figure 8

Note: Cb: Total capacitance of all BUS (unit: pF)

Pulse Input Conditions / $Ta = -10^{\circ}C$ to $+70^{\circ}C$, $V_{SS} = 0V$

Danamatan	O. made ad	Diag	Constitions.			Limi	ts	
Parameter	Symbol	Pins	Conditions	V _{DD} [V]	min	typ	max	unit
High/low level pulse	tPIH(1)	• INT0, INT1	Interrupt acceptable	4.5 to 5.5	1			
width	tPIL(1)	• INT2/T0IN	Timer 0-countable	4.5 to 5.5	ļ			
	tPIH(2)	INT3/T0IN	Interrupt acceptable					
	tPIL(2)	(1 tCYC is selected for	Timer 0-countable	4.5 to 5.5	2			
		noise rejection clock.)						
	tPIH(3)	INT3/T0IN	Interrupt acceptable					tCYC
	tPIL(3)	(16 tCYC is selected for	Timer 0-countable	4.5 to 5.5	32			
		noise rejection clock.)						
	tPIH(4)	INT3/T0IN	Interrupt acceptable					
	tPIL(4)	(64 tCYC is selected for	Timer 0-countable	4.5 to 5.5	128			
		noise rejection clock.)						
	tPIL(5)	RES	Reset acceptable	4.5 to 5.5	200			
	tPIH(6)	HS, VS	Display position					
	tPIL(6)		controllable (Note)					
			The active edge of HS	4.5 to 5.5	3			μs
			and VS must be apart	4.5 (0 5.5	3			
			at least 1 tCYC.					
			Refer to figure 4.					
Rising/falling time	tTHL	HS	Refer to figure 4.	4.5 to 5.5			500	ns
	tTLH			7.0 10 0.0			500	113

AD Converter Characteristics / Ta = -10°C to +70°C, $V_{SS} = 0V$

Danamatan	Comple at	Pins				S		
Parameter	Symbol Pins		Conditions	V _{DD} [V]	min	typ	max	unit
Resolution	N					6		bit
Absolute precision	ET		(Note)				±1	LSB
Conversion time	tCAD	Vref selection to conversion finish	1-bit conversion time = 2 × tCYC	4.5 to 5.5		1.69		μs
Analog input voltage range	VAIN	AN4 to AN7			V _{SS}		V_{DD}	V
Analog port	IAINH]	VAIN = V _{DD}				1	
input current	IAINL	1	VAIN = V _{SS}		-1			μΑ

Note: Absolute precision does not include quantizing error (1/2LSB).

Analog Mode RGB Characteristics / $Ta = -10^{\circ}C$ to $+70^{\circ}C$, $V_{SS} = 0V$

Parameter	Symbol	Pins	Conditions			Limit	s	
ratameter Symbol Filis	Conditions	V _{DD} [V]	min	typ	max	unit		
Analog output		R. G. B	Low level output		0.45	0.5	0.55	
voltage		Analog output mode	Intensity output	5.0	0.90	1.0	1.10	V
			Hi level output	5.0	1.35	1.5	1.65	
Time setting		R. G. B	70% 10pf load				50	ns

Sample Current Dissipation Characteristics / $Ta = -10^{\circ}C$ to $+70^{\circ}C$, $V_{SS} = 0V$

The sample current dissipation characteristics are the measurement result of SANYO provided evaluation board when the recommended circuit parameters shown in the sample oscillation circuit characteristics are used externally.

The currents through the output transistors and the pull-up MOS transistors are ignored.

Parameter	Symbol	Pins	Conditions			Limit	s	
raiaillelei	Syllibol	FILIS	Conditions	V _{DD} [V]	min	typ	max	unit
Current dissipation during basic operation (Note 3)	IDDOP(1)	V _{DD}	FmX'tal = 32.768kHz X'tal oscillation System clock: VCO VCO for OSD operating OSD is Digital mode Internal RC oscillation stops	4.5 to 5.5		14	28	
	IDDOP(2)	V _{DD}	FmX'tal = 32.768kHz X'tal oscillation System clock: VCO VCO for OSD operating OSD is Analog mode Internal RC oscillation stops	4.5 to 5.5		22	40	mA
	IDDOP(3)	V _{DD}	FmX'tal = 32.768kHz X'tal oscillation System clock : X'tal (Instruction cycle time : 366.2µs) VCO for system VCO for OSD, internal RC oscillation stop Data slicer, AD converters stop	4.5 to 5.5		50	300	μА
Current dissipation in HALT mode (Note 3)	IDDHALT(1)	V _{DD}	HALT mode FmX'tal = 32.768kHz X'tal oscillation System clock : VCO VCO for OSD stops Internal RC oscillation stops	4.5 to 5.5		4	10	mA
	IDDHALT(2)	V _{DD}	HALT mode FmX'tal = 32.768kHz X'tal oscillation VCO for system stops VCO for OSD stops System clock : Internal RC	4.5 to 5.5		300	1000	
	IDDHALT(3)	V _{DD}	HALT mode FmX'tal = 32.768kHz X'tal oscillation VCO for system stops VCO for OSD stops System clock: X'tal (Instruction cycle time: 366.2µs)	4.5 to 5.5		35	200	μА
Current dissipation in HOLD mode (Note 3)	IDDHOLD	V _{DD}	HOLD mode All oscillation stops.	4.5 to 5.5		0.05	20	μА

Note 3: The currents through the output transistors and the pull-up MOS transistors are ignored.

Recommended Oscillation Circuit and Sample Characteristics

The sample oscillation circuit characteristics in the table below is based on the following conditions:

- Recommended circuit parameters are verified by an oscillator manufacturer using a SANYO provided oscillation evaluation board.
- Sample characteristics are the result of the evaluation with the recommended circuit parameters connected externally.

Recommended oscillation circuit and sample characteristics ($Ta = -10 \text{ to } +70^{\circ}\text{C}$)

Frequency	Manufacturer	Oscillator	Recommended circuit parameters				Operating supply	Oscillation stabilizing time		Notes
			C1	C2	Rf	Rd	voltage range	typ	max	
32.768kHz	Seiko Epson	C-002RX	18pF	18pF	OPEN	390kΩ	4.5 to 5.5V	1.00S	1.50S	

Notes: The oscillation stabilizing time period is the time until the VCO oscillation for the internal system becomes stable after the following conditions. (Refer to Figure 2.)

- 1. The V_{DD} becomes higher than the minimum operating voltage after the power is supplied.
- 2. The HOLD mode is released.

The sample oscillation circuit characteristics may differ applications. For further assistance, please contact with oscillator manufacturer with the following notes in your mind.

- Since the oscillation frequency precision is affected by wiring capacity of the application board, etc., adjust the oscillation frequency on the production board.
- The above oscillation frequency and the operating supply voltage range are based on the operating temperature of -10°C to +70°C. For the use with the temperature outside of the range herein, or in the applications requiring high reliability such as car products, please consult with oscillator manufacturer.
- When using the oscillator which is not shown in the sample oscillation circuit characteristics, please consult with SANYO sales personnel.

Since the oscillation circuit characteristics are affected by the noise or wiring capacity because the circuit is designed with low gain in order to reduce the power dissipation, refer to the following notices.

- The distance between the clock I/O terminal (XT1 terminal XT2 terminal) and external parts should be as short as possible.
- The capacitors' VSS should be allocated close to the microcontroller's GND terminal and be away from other GND.
- The signal lines with rapid state changes or with large current should be allocated away from the oscillation circuit.

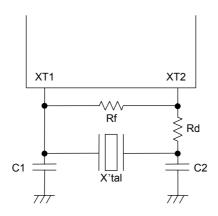
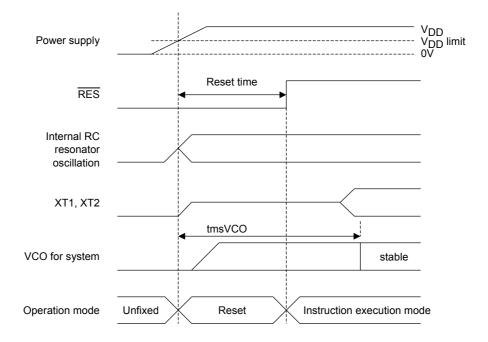
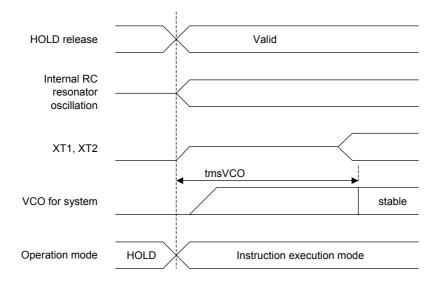


Figure 1 Recommended oscillation circuit



<Reset time and oscillation stabilizing time>



<HOLD release signal and oscillation stabilizing time>

Figure 2 Oscillation stabilizing time

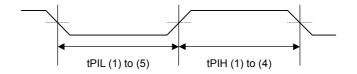


Figure 3 Pulse input timing condition - 1

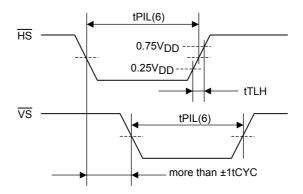


Figure 4 Pulse input timing condition - 2

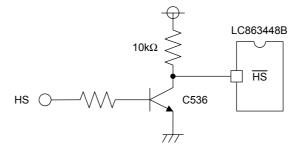
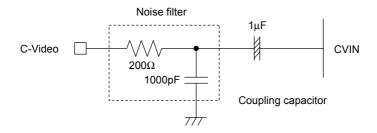


Figure 5 Recommended Interface circuit



Output impedance of C-Video before Noise filter should be less then 100Ω .

Figure 6 CVIN recommended circuit

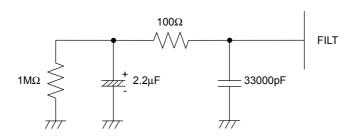
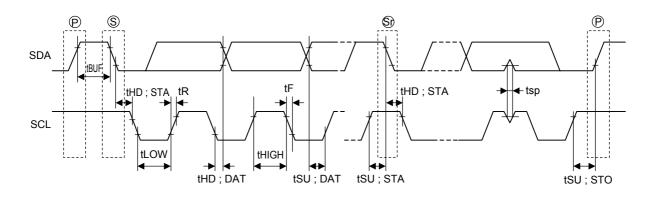


Figure 7 FILT recommended circuit

Note: Place FILT parts on board as close to the microcontroller as possible.



S : start condition
P : stop condition
Sr : restart condition

tsp: Spike suppression

Standard mode : not exist High speed mode : less than 50ns

Figure 8 IIC timing

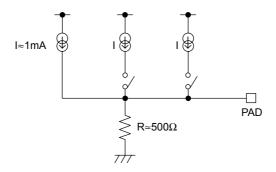


Figure 9 R. G. B. analog output equivalent circuit

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